PCN Number	er:		2023	3040	06000.1		PC	N D	ate	e: A	pril 06, 2023		
Title: Qualification of DMOS6 as an additional Fab site option for select LBC9 devices							BC9 devices						
Customer Contact:			PCN Manager			Dept:			_	Quality Services			
Proposed 1 st Ship Date:			Jul	6, 2023		Sample requests accepted until:				May 6, 2023*			
*Sample re	equest	s recei	ved a	afte	r May 6, 202	3 will	not be s	upp	or	ted.			
Change Typ													
Assemb	ly Site			Assembly Process						ly Materials			
Design			Electrical Specificat							nanical Specification			
Test Sit		ih o		H	Packing/Ship			l	\mathbb{H}		Test Process		
✓ Wafer Bump Site✓ Wafer Fab Site			1	☐ Wafer Bump Material ☐ Wafer Fab Materials			+	 		Wafer Bump Process Wafer Fab Process			
Zu Walei i	מט אונפ			1	Part number change			- 1	<u> </u>	water	I ab Flocess		
					PCN E								
Description	n of Ch	ange:				Ctar							
	Texas Instruments is pleased to announce the qualification of its DMOS6 fabrication facility as an												
					selected devi								
Current Fab Si				te			Additional Fab				Site		
Current F Site	Current Fab Process Site			Wafer Diameter	_		Process		ocess	Wafer Diameter			
RFAB		LBC	9		300mm	DI	DMOS6			BC9	300mm		
Qual details are provided in the Qual Data Section.													
Reason for			in the	· Qua	ai Data Sectio	<u> </u>							
Continuity o													
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):													
None													
Changes to	produ	ıct ide	ntific	atio	n resulting f	rom t	his PCN:						
Fab Site In	format	tion:											
Chip Si	ite	Chip	Site (Origi	n Code (20L)	Chip	Site Cou	ntry	/ C	ode (211	L) Chip Site City		
RFAB		RFB			USA				Richardson				
DMOS6		DM	16		USA			Dallas					
MADE IN: N 2DC: MSL 2 /260 MSL 1 /235 OPT: ITEM:	S ENTS Malaysi 20: DC/1 YE 5C/UNLI	a AR SEAI	G4 L DT 29/04		actual produc) 1P) \$N7/ (Q) 200 31T) LOT 4W) TKY P) REV. 20L) CSO: 22L) ASO:	0 [:::3 (11	39: ()	(D) (0 59047M 752348	ILA 83\$12 33317 0:USA		
Product Af	fected												

TAS2110RPPR

TAS2110RPPT

Qualification Report Approve Date 24-MARCH -2023

Oualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: TAS2110RPPR	QBS Reference: BQ25910YFFR	QBS Reference: PTAS2110RPPR	QBS Reference: TAS2563RPPR
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	3/231/0	3/231/0	3/231/0
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	-	3/231/0	3/231/0	3/231/0
TC	A4	Temperature Cycle	-55C/125C	700 Cycles	-	3/231/0	-	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	3/231/0	3/231/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	-	3/231/0	-
HTSL	A6	High Temperature Storage Life	170C	420 Hours	-	3/231/0	3/231/0	-
HTOL	B1	Life Test	140C	480 Hours	-	3/231/0	-	-
HTOL	B1	Life Test	150C	300 Hours	-	-	-	1/77/0
ELFR	B2	Early Life Failure Rate	150C	24 Hours	-	3/2400/0	-	-
SD	C3	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes); PB-Free Solder;	-	-	-	3/66/0	-
PD	C4	Physical Dimensions	(per mechanical drawing)	-	-	-	3/60/0	-
ESD	E2	ESD CDM	-	1500 Volts	1/3/0	3/9/0	1/3/0	-
ESD	E2	ESD HBM	-	2000 Volts	1/3/0	-	-	-
LU	E4	Latch-Up	Per JESD78	-	1/3/0	3/18/0	1/6/0	1/6/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	1/30/0	1/30/0

- . OBS: Oual By Similarity
- Qual Device TAS2110RPPR is qualified at MSL2 260C
- · Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the contact shown below, or you can contact your local Field Sales Representative.

Location	E-Mail					
WW Change Management Team	PCN www admin_team@list.ti.com					

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